

Electronic housing - ME-IO 18,8 DEV-KIT KMGY - 2202527

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DEV-KIT ME-IO: contains 1 x ME-IO 18,8 housing and pluggable connection technology (HSCH with HSCP), supplied in individual parts

Product Features

- Narrow housing with overall width of 18.8 mm
- Plug-in front connection technology
- Optional hole matrix PCB for soldering THT components by hand
- Connection of individual housing modules by means of the optional ME TBUS via DIN rail
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Key commercial data

Packing unit	1 pc
Weight per Piece (excluding packing)	90.0 GRM
Custom tariff number	85366990
Country of origin	Germany

Technical data

General

Housing type	Component housing
Housing material	Polyamide
Color	light gray

Ambient conditions

Ambient temperature (operation)	-40 °C ... 105 °C (depending on power dissipation)
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Dimensions

Width	18.8 mm
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Technical data

Inflammability class according to UL 94	V0
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Classifications

eCl@ss

eCl@ss 4.0	27180401
eCl@ss 4.1	27180401
eCl@ss 5.0	27180506

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Classifications

eCl@ss

eCl@ss 5.1	27180506
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ETIM

ETIM 3.0	EC001031
ETIM 4.0	EC001031
ETIM 5.0	EC001031

UNSPSC

UNSPSC 6.01	31261501
UNSPSC 7.0901	31261501
UNSPSC 11	31261501
UNSPSC 12.01	31261501
UNSPSC 13.2	31261501

Accessories

Additional products

PCB - ME-IO 18,8/28 TBUS DEV-PCB - 2202548

Plug - ME 18,8 TBUS 1,5/5 VPE1 KMGY - 2202549

